

Data sheet acquired from Harris Semiconductor SCHS091B – Revised July 2003

CD4585B Types

CMOS 4-Bit Magnitude Comparator

High Voltage Types (20-Volt Rating)

■ CD4585B is a 4-bit magnitude comparator designed for use in computer and logic applications that require the comparison of two 4-bit words. This logic circuit determines whether one 4-bit word (Binary or BCD) is "less than", "equal to", or "greater than" a second 4-bit word.

The CD4585B has eight comparing inputs (A3, B3, through A0, B0), three outputs (A <B, A = B, A > B) and three cascading inputs (A < B, A = B, A > B) that permit systems designers to expand the comparator function to 8, 12, 16......4N bits. When a single CD4585B is used, the cascading inputs are connected as follows: (A < B) = low, (A = B) = high, (A > B) = high.

Cascading these units for comparison of more than 4 bits is accomplished as shown in Fig. 13.

The CD4585B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- Expansion to 8,12,16.....4N bits by cascading units
- Medium-speed operation:

compares two 4-bit words in 180 ns (typ.) at 10 V

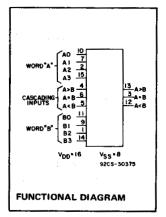
- 100% tested for quiescent current at 20 V
- Standardized symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 μA at 18 V over full package temperature range;
 100 nA at 18 V and 25°C
- Noise margin (full package temperature range) range) = 1 V at V_{DD} = 5 V

2 V at V_{DD} = 10 V 2.5 V at V_{DD} = 15 V

Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

■ Servo motor controls
■ Process controllers



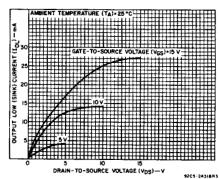
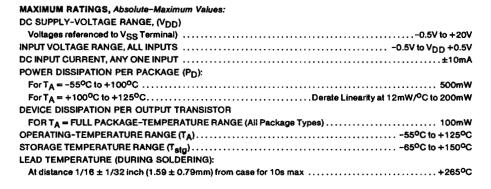


Fig.1 — Typical output low (sink) current characteristics.



RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

LIM	ITS	LINUTO
Min.	Max.	UNITS
3	18	٧

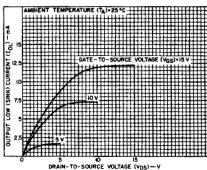


Fig.2 – Minimum output low (sink) current characteristics.

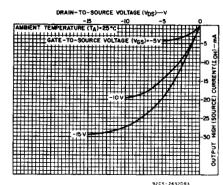


Fig.3 - Typical output high (source) current characteristics.

CD4585B Types

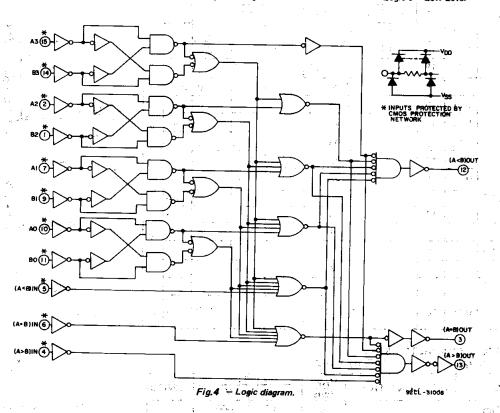
TRUTH TABLE

			NPUTS							
COMPARING				C	ASCADI	NG	OUTPUTS			
A3, B3	A2, B2	A1, B1	A0, B0	A < B	A = B	A > B	A < B	A=B	A>B	
A3 > B3 A3 = B3	X A2>B2	X	X	X	X	1	0	0	-1	
A3 = B3 A3 = B3	A2 = B2 A2 = B2	A1 > B1 A1 = B1	X A0> B0	X X	x X	1	0	0		
A3 = B3 A3 = B3 A3 = B3	A2 = B2 A2 = B2 A2 = B2	A1 = B1 A1 = B1 A1 = B1	A0 = B0 A0 = B0 A0 = B0	0 0	0	1 X X	0	0	1 0	
A3 = B3 A3 = B3	A2 = B2 A2 = B2	A1 = B1 A1 < B1	A0 < B0 X	X	X X	X	1 1	0	0	
A 3 = B3 A3 < B3	A2 < B2 X	X	X X	X	X	X	1 1	* 0 0	0	

X = Don't Care

Logic 1 = High Level

Logic 0 = Low Level



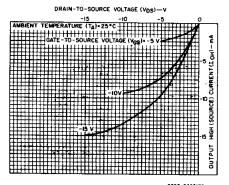


Fig. 5 — Minimum output high (source) current characteristics.

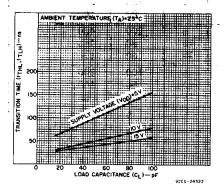


Fig. 6 — Typical transition time as a function of load capacitance.

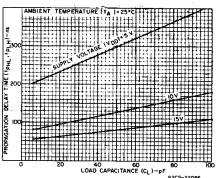


Fig. 7 — Typical propagation delay time ("comparing inputs" to outputs) as a function of load capacitance.

CD4585B Types

CHARAC- TERISTIC	CON	DITIO	NS	LIN	MITS AT	INDICAT	red tew	IPERAT	URES (⁰	(C)	UN - T
	vo	VIN	v_{DD}						+25		s
	(V)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent	_	0,5	5	5	5	150	150	_	0.04	5	
Device	-	0,10	10	10	10	300	300	_	0.04	10	μΑ
Current,	-	0,15	15	20	20	600	600	-	0.04	20	ľ
IDD Max.	_	0,20	20	100	100	3000	3000	_	0.08	100	
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	1	
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-]
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	1	
Outros High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
Output High (Source) Current,	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	_	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_	
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	_	
Output Voltage:	-	0,5	5		0.	_	0	0.05			
Low-Level,	-	0,10	10		0	.05		-	0	0.05	
VOL Max.	-	0,15	15		0	.05		-	0	0.05	v
Output	_	0,5	5		4.	.95		4.95	5	_	
Voltage:	_	0,10	10		9	.95		9.95	10		
High-Level, V _{OH} Min.	-	0,15	15		14	.95		14.95	15	_	
1	0.5,4.5	-	5		•	1.5		-	-	1.5	Π
Input Low Voltage	1,9		10			3		_	-	3	
V _{IL} Max.	1.5,13.5	_	15			4		_	-	4] v
Input High	0.5,4.5	_	5		;	3.5		3.5		_	
Voltage,	1,9	-	10			7		7	_	_	
V _{IH} Min.	1.5,13.5	_	15			11		11	_		L
		-	•							1	$\overline{}$

DYNAMIC ELECTRICAL CHARACTERISTICS

0,18

Input Current

I_{IN} Max.

At $T_A = 25^{\circ}C$; Input t_r , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ k Ω

18

±0.1

		Vnn	LIM	ITS	Ι
CHARACTERISTIC	TEST CONDITIONS	V _{DD} Volts	Тур.	Max.	UNITS
Propagation Delay Time: Comparing Inputs to Outputs, tphl, tplh		5 10 15	300 125 80	600 250 160	ns
Cascading Inputs to Outputs, tpHL, tpLH	5 200 scading Inputs to 10 80	400 160 120			
Transition Time, ^t THL ^{, t} TLH		5 10 15	100 50 40	200 100 80	ns
Input Capacitance, C _{IN}	Any Input	* * * ·	5	7.5	pF

±0.1

±1

±1

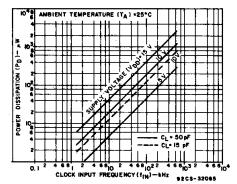


Fig. 8 — Typical dynamic power dissipation as a function of clock input frequency (see Fig. 9—dynamic power dissipation test circuit).

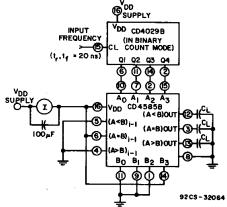


Fig. 9 - Dynamic power dissipation test circuit.

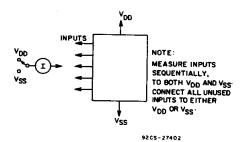


Fig. 10 - Input current test circuit.

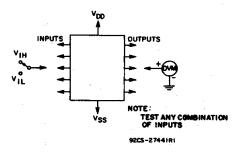


Fig. 11 - Input-voltage test circuit.

±10⁻⁵

±0.1

CD4585B Types

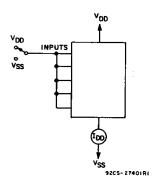


Fig. 12 - Quiescent-device-current test circuit.

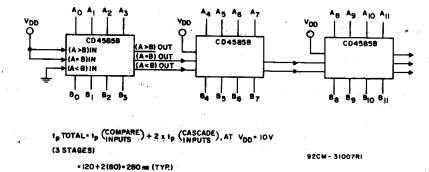
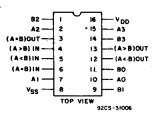
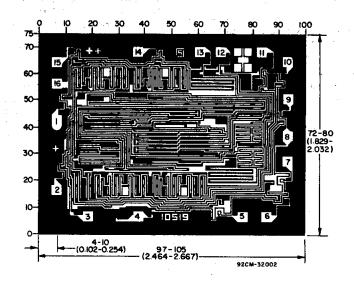


Fig. 13 - Typical speed characteristics of a 12-bit comparator.

TERMINAL ASSIGNMENT





Dimensions and Pad Layout for CD45858H

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3}) inch).

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29-May-2025

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	3		Part marking (6)
						(4)	(5)		
7703702EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7703702EA CD4585BF3A
CD4585BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4585BE
CD4585BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4585BE
CD4585BEE4	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4585BE
CD4585BF3A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7703702EA CD4585BF3A
CD4585BF3A.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7703702EA CD4585BF3A
CD4585BNSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4585B
CD4585BNSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4585B
CD4585BPW	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM585B
CD4585BPW.A	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM585B
CD4585BPWE4	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM585B
CD4585BPWG4	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM585B

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF CD4585B, CD4585B-MIL:

Catalog : CD4585B

Military: CD4585B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

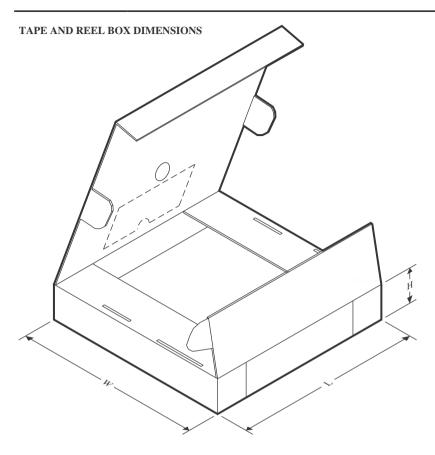


*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4585BNSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4585BNSR	SOP	NS	16	2000	353.0	353.0	32.0

PACKAGE MATERIALS INFORMATION

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TUBE

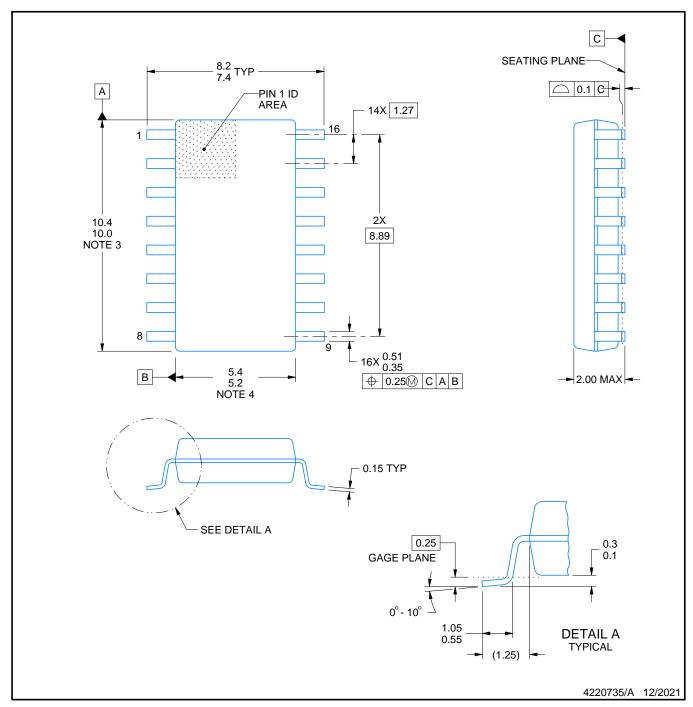


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD4585BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD4585BPW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4585BPW.A	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4585BPWE4	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4585BPWG4	PW	TSSOP	16	90	530	10.2	3600	3.5



SOP



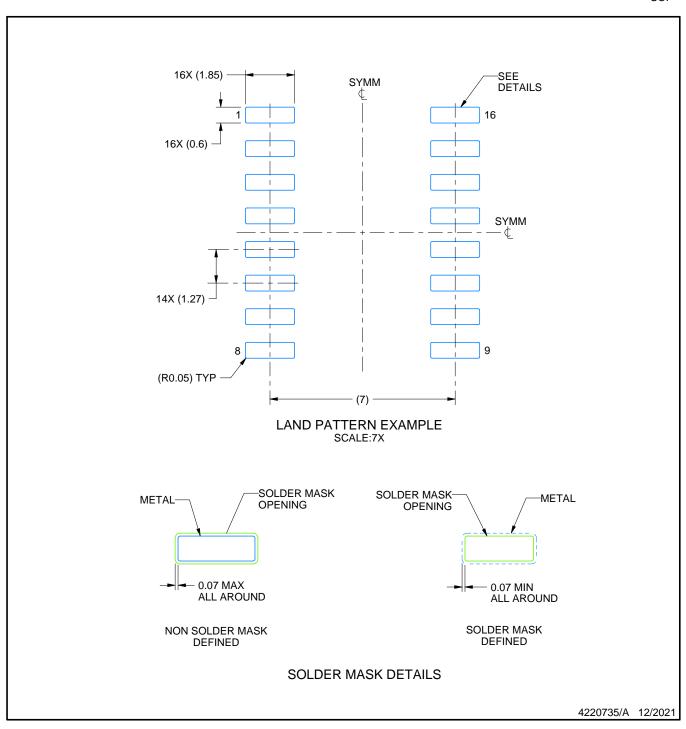
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



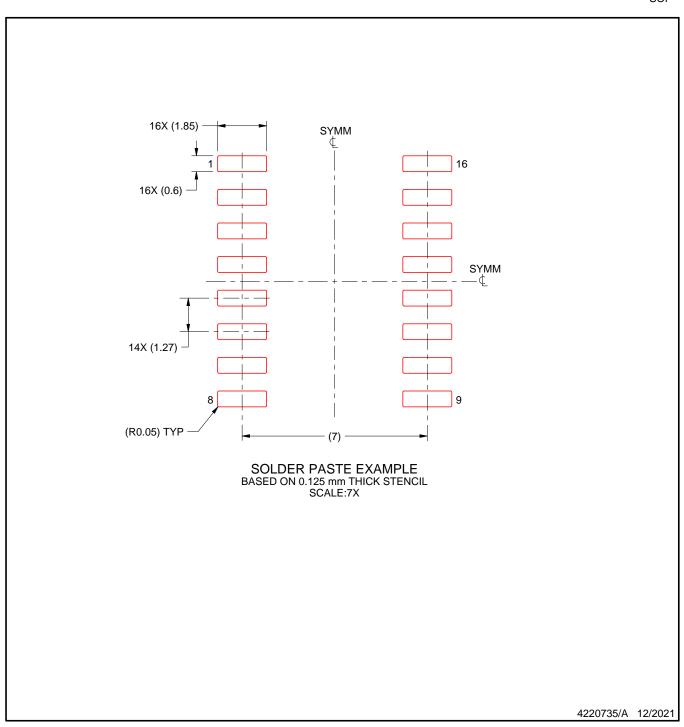
SOF



- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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